### **Features**

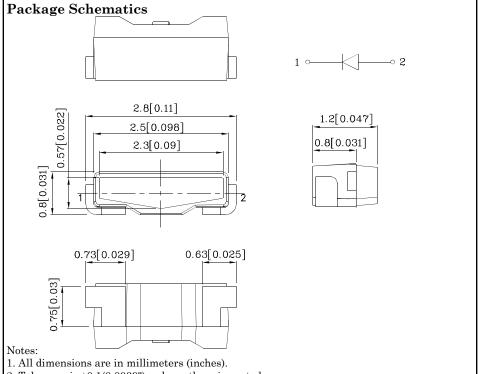
- Ideal for indication light on hand held products
- Long life and robust package
- Variety of lens types and color choices available
- ullet Package : 2000pcs / reel
- Moisture sensitivity level : level 3
- RoHS compliant







# ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



- 2. Tolerance is  $\pm 0.1(0.0039")$  unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)	M2DG (InGaN)	Unit			
Reverse Voltage	$V_{\mathrm{R}}$	5	V		
Forward Current	$I_{\mathrm{F}}$	30	mA		
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	100	mA		
Power Dissipation	$P_{D}$	120	mW		
Operating Temperature	$T_{\mathrm{A}}$	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +85	C		

Operating Characteristics (T <sub>A</sub> =25°C)		M2DG (InGaN)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	3.2	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	4	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	50	uA
Wavelength of Peak Emission (Typ.) $(I_F=20 \text{mA})$	λΡ	520	nm
Wavelength of Dominant Emission (Typ.) $(I_F=20 \text{mA})$	λD	525	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	35	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous} \\ \text{Intensity} \\ \text{(I}_F = 20 \text{mA)} \\ \text{mcd} \end{array}$		Wavelength nm λΡ	Viewing Angle 20 1/2
				min.	typ.		
XZM2DG81FS	Green	InGaN	Water Clear	1000	1495	520	110°

Mar 17,2011 XDSB5695 V1 Layout: Maggie L.



### www.SunLEDusa.com

### **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

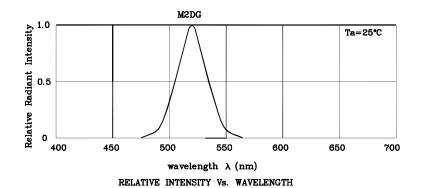


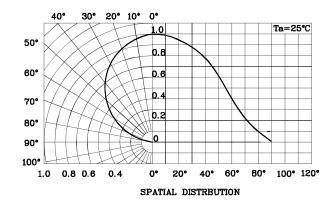
2. As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Mar 17,2011

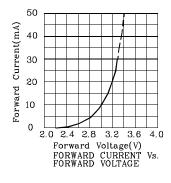


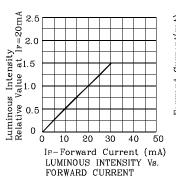


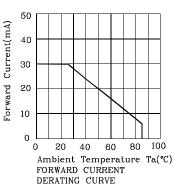


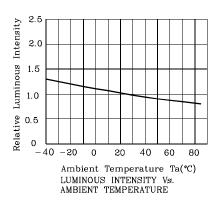


### **❖** M2DG



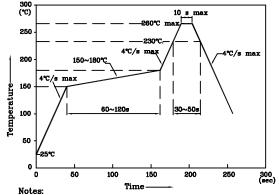






## LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)



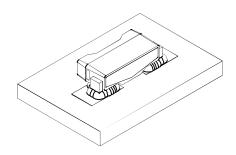
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions

Mar 17,2011

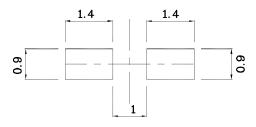
XDSB5695 V1 Layout: Maggie L.



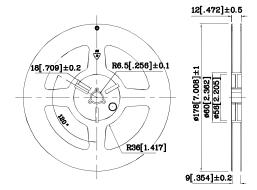
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



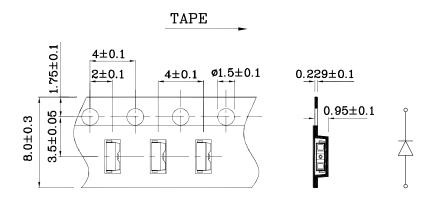
**♦** Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### \* Reel Dimension



### **❖** Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

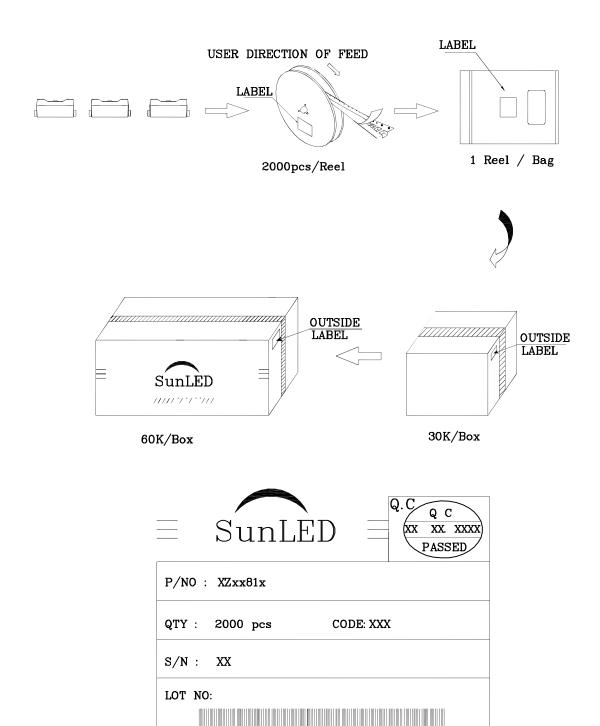
Note: Accuracy may depend on the sorting parameters.

Mar 17,2011

XDSB5695 V1 Layout: Maggie L.



### PACKING & LABEL SPECIFICATIONS



Mar 17,2011

RoHS Compliant